


Decoder/Demultiplexer Single 2-to-3 8-Pin SSOP T/R

Manufacturer:	Texas Instruments, Inc
Package/Case:	SM8
Product Type:	Logic ICs
RoHS:	RoHS Compliant/Lead free 
Lifecycle:	Active



Images are for reference only

[Inquiry](#)

General Description

This decoder is designed for 1.65-V to 5.5-V VCC operation.

The SN74LVC1G29 device is a 2-of-3 decoder/demultiplexer. When the enable (G) input signal is low, only one of the outputs is in the low state, depending on the input levels of A0 and A1. When G is high, Y0, Y1, and Y2 are high, regardless of the input states.

This device is fully specified for partial-power-down applications using Ioff. The Ioff circuitry disable the outputs, preventing damaging current backflow through the device when it is powered down.

NanoFree package technology is a major breakthrough in IC packaging concepts, using the die as the package.

Key Features

Available in the Texas Instruments NanoFree Package

Supports 5-V VCC Operation

Inputs Accept Voltages to 5.5 V

Supports Down Translation to VCC

Max tpd of 5.1 ns at 3.3 V

Low Power Consumption, 10- μ A Max ICC

\pm 24-mA Output Drive at 3.3 V

Typical VOLP (Output Ground Bounce) <0.8 V at VCC = 3.3 V, TA = 25°C

Typical VOHV (Output VOH Undershoot) >2 V at VCC = 3.3 V, TA = 25°C

Ioff Supports Live Insertion, Partial-Power-Down Mode, and Back-Drive Protection

Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II

ESD Protection Exceeds JESD 22
2000-V Human-Body Model (A114-A)

200-V Machine Model (A115-A)

1000-V Charged-Device Model (C101)

Description

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Recommended For You

SN74S38N

Texas Instruments, Inc

DIP

SN7438N

Texas Instruments, Inc

DIP14

SN75462P

Texas Instruments, Inc

DIP8

SN74F08D

Texas Instruments, Inc

SOP-14

SN74LS257BN

Texas Instruments, Inc

DIP16

SN75452BP

Texas Instruments, Inc

DIP8

SN74LS245DW

Texas Instruments, Inc

SOP20

SN74LS74AN

Texas Instruments, Inc

DIP

SN74S74N

Texas Instruments, Inc

DIP

SN7406N

Texas Instruments, Inc

DIP-14

SN74CBTLV3257D

Texas Instruments, Inc

SOP-16P

SN74HC138DR

Texas Instruments, Inc

SOP16

SN74LS14N

Texas Instruments, Inc

DIP

SN74HC139N

Texas Instruments, Inc

DIP

SN74AVC16T245DGGR

Texas Instruments, Inc

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